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Attorney Docket No. UMC-96-279 CON
Client Matter No. 81848.0016.001
Confirmation No. 4793

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Chih-Chien LIU, et al

Serial No. 09/546,174

Filed: April 11, 2000

For: HIGH DENSITY PLASMA CHEMICAL
VAPOR DEPOSITION PROCESS

Examiner: 1711

Art Unit: R. SERGENT

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CERTIFICATE OF MAILING BY EXPRESS MAIL

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

The undersigned hereby certifies that the following documents:

1. Amendment and Response to Communication Dated September 13, 2001;
2. Check for \$1,742.00;
3. Terminal Disclaimer;
4. Petition for 5- Month Extension;
5. Certificate of Mailing by Express Mail; and
6. Return postcard,

relating to the above application, were deposited as "Express Mail", Mailing Label No. EL 936770671 with the United States Postal Service, addressed to The Assistant Commissioner for Patents, Washington, D.C., 20231, on March 12, 2002.

March 12, 2002

March 12, 2002

DeAn Sandor
Mailer

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Attorney Docket No. UMC-96-279 CON
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE *103*

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AMENDMENT AND RESPONSE TO
COMMUNICATION DATED SEPTEMBER 12, 2001

*Enclosed
Recd*
Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Communication mailed September 12, 2001, please amend the application as follows:

IN THE SPECIFICATION:

Please add the following paragraph beginning at page 1, line 1:

B1
This application is a continuation of U.S. Serial No. 08/958,460, now U.S. Patent No. 6,117,345.

IN THE CLAIMS:

Please cancel claims 21-37 previously withdrawn by the Examiner.

WV
Please re-enter original claims 1-20, with claims 1-9, 11-12 and 20 amended as follows, with marked up versions of the amended claims attached to this Response.

1. (Amended) A method for forming conducting structures separated by gaps on a substrate comprising:

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